

## **TECHNICAL DATA SHEET: PROTEC POE+**

POE encapsulants are formulated to offer the highest resistance against PID, UV, and moisture degradation. **PROTEC** series POEs are PID-free and offer some of the lowest moisture transmission rates in the industry. They are suitable to all crystalline (mono & bifacial) and thin film solar PV modules. **PROTEC POE+ HT** is a high light transmission material suitable for use as a front encapsulant, while **PROTEC POE+ UV** is highly UV resistant and is intended for use as a back encapsulant.

# **Performance parameters**

| S. N | Parameter                         |                | unit  | Test method | POE+ HT           | POE+ UV                  |                          |
|------|-----------------------------------|----------------|-------|-------------|-------------------|--------------------------|--------------------------|
| 1    | Thickness                         |                |       | μm          | Micrometer        | 200 to 800<br>(±5%)      | 200 to 800<br>(±5%)      |
| 2    | Weight                            |                |       | g/m2        | Balance           | 150 to 650<br>(±5%)      | 150 to 650<br>(±5%)      |
| 3    | Width                             |                |       | mm          | Scale             | Customization<br>(+7/-0) | Customization<br>(+7/-0) |
| 4    | Length                            |                |       | M/roll      | Protec            | 100 - 400                | 100 - 400                |
| 5    | Melting Range                     |                |       | °C          | DSC               | 80-90                    | 80-90                    |
| 6    | Gel content                       |                |       | %           | Soxhlet           | 2                        | ≥ 60                     |
| _    | Thermal Shrinkage MD TD           |                | MD    | %           | 120 °C, 3 min     | <u>⊊</u> 3               | ≤3                       |
| 7    |                                   |                | TD    | %           |                   | ≤ 1.5<br>300             | ≤ 1.5                    |
| 8    | UV cut off wavelength             |                |       | nm          | <b>ASTM E 424</b> | 300                      | 380                      |
| 9    | Transmittance                     | 1100 nm-380 nm |       | %           | ASTM E 424        | ≥ 91                     | ≥ 91                     |
| 9    |                                   | 380 nm-290 nm  |       | %           | <b>ASTM E 424</b> | ≥ 80                     | ≤ 30                     |
| 10   | MVTR (38C)                        | MVTR (38C)     |       | g/m2/24hrs  | ASTM F 1249       | 4.2                      | 4.2                      |
| 11   | Adhesion Strength Glass Backsheet |                | Glass | N/cm        | ASTM D 903        | ≥ 60                     | ≥ 60                     |
| 11   |                                   |                | N/cm  | ASTM D 903  | ≥ 40              | ≥ 40                     |                          |
| 12   | Tensile strength MD               |                |       | MPa         | ASTM D 638        | ≥ 10 MPa                 | ≥ 10 MPa                 |
| 12   | TD                                |                | TD    | MPa         | ASTM D 638        | ≥ 10 MPa                 | ≥ 10 MPa                 |
| 13   | Elongation                        |                |       | %           | ASTM D 638        | ≥ 500                    | ≥ 500                    |
| 14   | Volume Resistivity                |                |       | Ohm.m       | ASTM D 257        | ≥ 5×10 <sup>16</sup>     | ≥ 5×10 <sup>16</sup>     |

# **Lamination Recommendations (Glass/Glass):**

| Laminator configuration           | Single stage | Multistage | Multi stack |
|-----------------------------------|--------------|------------|-------------|
| Evacuation time (min)             | 6-8          | 2-3        | 3-4         |
| Evacuation temp (°C)              | 150-160      | 160-160    | 150-160     |
| 1 <sup>st</sup> -Press time (min) |              | 1-3        |             |
| 1 <sup>st</sup> -Press temp (°C)  |              | 150-160    | 150-160     |
| Curing time (min)                 | 8-10         | 6-8        | 4-8         |
| Curing temp (°C)                  | 150-160      | 150-160    | 150-160     |

Temperature & time are indicative to start with. Different makes & models of laminators behave differently. Membrane pressure is very critical for POE lamination, all conventional laminators should be operated around 400-600 mbar during pressing and all advanced glass to glass laminator can be operated as per manufacturer instruction.

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**Storage conditions & Usage period:** Store unopened original packaging at storage temperature of 25°C to 30°C and storage humidity < 60% RH. Recommended to use within 6 months from date of manufacturing.

#### **Operational benefits**

- State of the art highly precise automation from raw material pick up to finish roll packing
- Raw material from highly reputed manufacturers
- State of the art Laboratory having facility to check 100% raw material critical parameters
- Very clean manufacturing environment and premises

#### **Product Processing advantages**

- Suitable for glass to glass & glass to backsheet lamination process
- Suitable to conventional as well as all advanced lamination technologies, easy to run.
- Designed to match with all solar cell technology to yield max output
- Wrinkle & wave free flat sheet which prevents cell microcrack formation
- Both side embossing structure to give maximum solar cell visibility for defect inspection at pre lam stages
- Special surface texture to give optimum griping to solar cell, glass & backsheet to prevent any slippage of solar cell string during conveyor motion and layup movement

#### **Product technical advantages:**

- PID free Encapsulant
- High Damp heat resistance up 3000+ hours in glass backsheet & 5000+ hours in glass/glass
- High light transmission for max power yield.